## Si6943DQ

IRCHI

### Dual P-Channel 2.5V Specified PowerTrench<sup>®</sup> MOSFET

### **General Description**

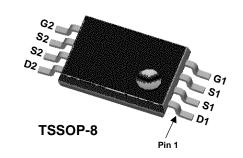
This P-Channel -2.5V specified MOSFET is a rugged gate version of Fairchild's Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (-2.5V to -8V).

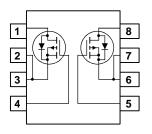
### Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

### Features

- Extended  $V_{\text{GSS}}$  range (±8V) for battery applications
- Low gate charge (4.6nC typical)
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





### Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbol		Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage			-12	V	
V <sub>GSS</sub>	Gate-Source	e Voltage	±8	V		
ID	Drain Curre	nt – Continuous	(Note 1)	-2.5	A	
		– Pulsed		-20		
P <sub>D</sub>	Power Dissipation for Single Operation		(Note 1a)	1.0	W	
				0.6		
T <sub>J</sub> , T <sub>STG</sub>	Operating a	and Storage Junction Temperature Range		-55 to +150	°C	
Therma	I Charact	eristics				
$R_{\theta JA}$	Thermal Re	sistance, Junction-to-Ambie	ent (Note 1a)	100	°C/W	
	(Note 1			125		
Packag		g and Ordering Ir	nformation Reel Size	Tape width	Quantity	
6943		Si6943DQ	13"	12mm	2500 units	

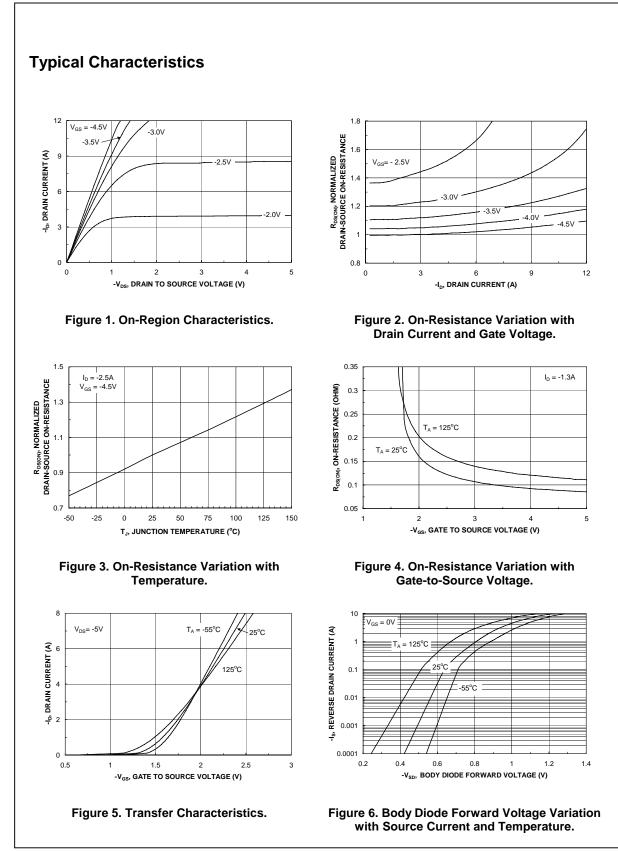
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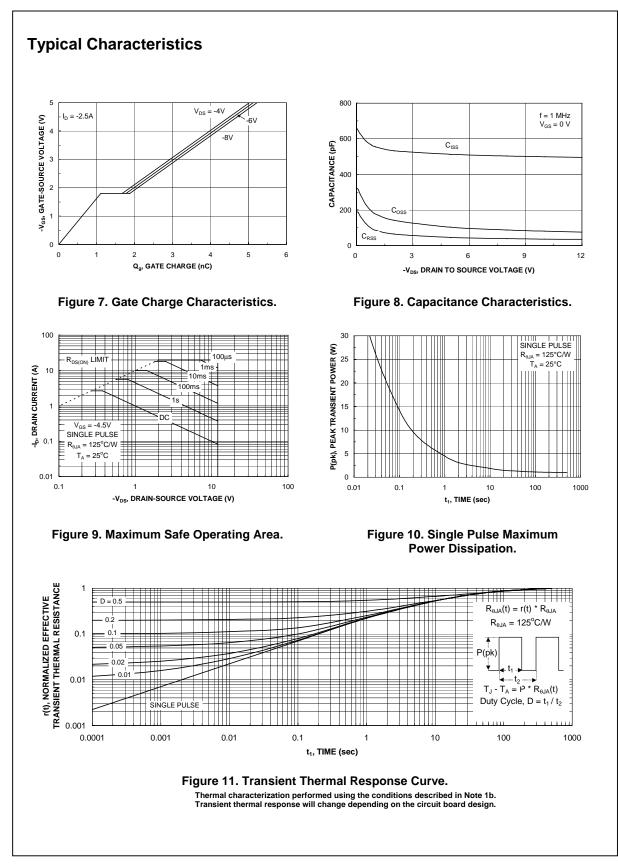
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	I		1		1
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = -250 \mu A$	-12			V
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 µA, Referenced to 25°C		-13		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\text{DS}} = -12 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			-1	μA
I <sub>GSSF</sub>	Gate-Body Leakage, Forward	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
I <sub>GSSR</sub>	Gate–Body Leakage, Reverse	$V_{GS} = 8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-0.6	-0.9	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		3		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$V_{GS} = -4.5 \text{ V},  I_D = -2.5 \text{ A}$ $V_{GS} = -2.5 \text{ V},  I_D = -1.9 \text{ A}$ $V_{GS} = -4.5 \text{ V},  I_D = -2.5 \text{ A},  T_H = 125^{\circ}\text{C}$		89 125 116	110 180 154	mΩ
I <sub>D(on)</sub>	On–State Drain Current		-10			Α
<b>g</b> fs	Forward Transconductance	$V_{DS} = -9 V$ , $I_D = -2.5 A$		7		S
Dvnamio	Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -6 V$ , $V_{GS} = 0 V$ ,		509		pF
Coss	Output Capacitance	f = 1.0 MHz		97		pF
Crss	Reverse Transfer Capacitance			43		pF
Switchir	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -6 V, \qquad I_D = -1 A,$		9	18	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$		12	22	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	-		17	31	ns
t <sub>f</sub>	Turn–Off Fall Time	-		8	16	ns
Q <sub>q</sub>	Total Gate Charge	$V_{DS} = -6V,$ $I_D = -2.5 A,$		4.6	6.4	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = -4.5 V$		1.1		nC
Q <sub>gd</sub>	Gate-Drain Charge			0.7		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain–Sourc				-1	А
	Drain-Source Diode Forward	$V_{GS} = 0 V$ , $I_{S} = -1 A$ (Note 2)		0.8	-1.2	V

a) R<sub>θJA</sub> is 100°C/W (steady state) when mounted on a 1 inch<sup>2</sup> copper pad on FR-4.
b) R<sub>θJA</sub> is 125°C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%



# Si6943DQ



Si6943DQ Rev. B (W)

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